

CDR31BP200BFSP-T&R

Aliases (C0805N200F1GPH7189)

SMD Mil PRF55681, Ceramic, 20 pF, 1%, 100 VDC, BP, P (0.1%/1000 Hrs), 0805



Click here for the 3D model.

Dimensions	
Chip Size	0805
L	2mm +0.8/-0.2mm (0.079 in +0.031/-0.008 in)
W	1.25mm +0.5/-0.2mm (0.049 in +0.02/-0.008 in)
Т	1.3mm +0.3mm (0.051 in +0.012 in)
В	0.5mm +0.5/-0.2mm (0.02 in +0.02/-0.008 in)

Packaging Specifications	
Packaging	T&R, 178mm, Plastic Tape
Packaging Quantity	2500

General Information	
Series	SMD Mil PRF55681
Style	SMD Chip
RoHS	No
Prop 65	▲ WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov.
SCIP Number	6d5c4aea-4874-4964-b195-433620b8c028
Termination	Lead (SnPb)
Failure Rate	P (0.1%/1000 Hrs)
Testing and Reliability	MIL-PRF-55681
Qualifications	MIL-PRF-55681
AEC-Q200	No
Miscellaneous	Termination Description: SolderCoat 60-40.
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	20 pF
Capacitance Tolerance	1%
Voltage DC	100 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	BP

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